# **MUR180**

#### ULTRAFAST EFFICIENT GLASS PASSIVATED RECTIFIER E: 800V CURRENT:1.0A



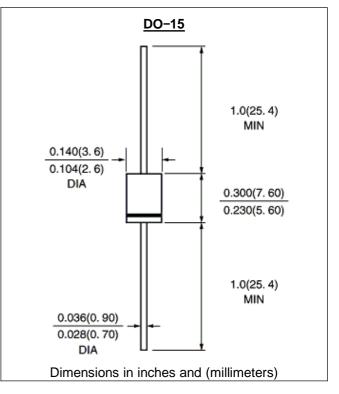
VOLTAGE: 800V

## FEATURE

Ultrafast Nanosecond Recovery Times 150°C Operating Junction Temperature Low Forward Voltage Low Leakage Current High Temperature Glass Passivated Junction

### **MECHANICAL DATA**

Case: Epoxy, Molded Weight: 0.4 gram (approximately) Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable solder heat resistance :265degreeC Max. for 10 Seconds, 1/16 from case Polarity: Cathode Indicated by Polarity Band



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	MUR180	units
Maximum Recurrent Peak Reverse Voltage	Vrrm	800	V
Maximum RMS Voltage	Vrms	640	V
Maximum DC blocking Voltage	Vdc	800	V
Maximum Average Forward Rectified	lf(av)	1.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	lfsm	35	A
Maximum Forward Voltage at rated Forward Current and 25°C	Vf	1.75	V
Maximum Reverse Recovery Time (Note 1)	Trr	75	nS
Maximum DC Reverse Current Ta = $25^{\circ}$ C	lr	10	μΑ
at rated DC blocking voltage Ta = $125^{\circ}$ C		50	μA
Typical Junction Capacitance (Note 2)	Cj	25	pF
Typical thermal resistance junction to ambient (Note 3)	Rth(ja)	50	C/W
Storage and Operating Temperature Range	Tstg, Tj	-55 to +150	O°

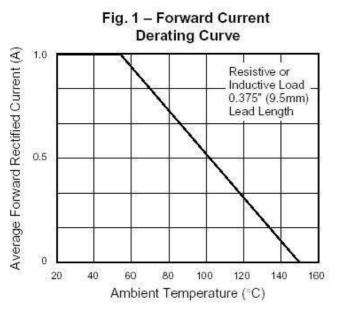
Note:

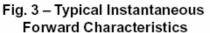
1. Reverse Recovery Condition If =0.5A, Ir =1.0A, Irr =0.25A

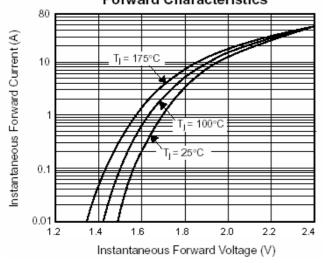
2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc

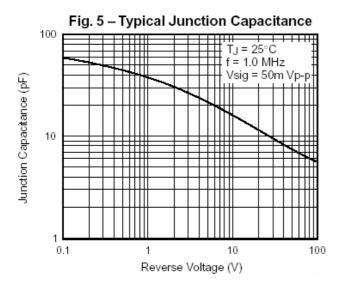
3. Thermal Resistance from Junction to Ambient at 3/8"lead length, P.C. Board Mounted

#### **RATINGS AND CHARACTERISTIC CURVES MUR180**









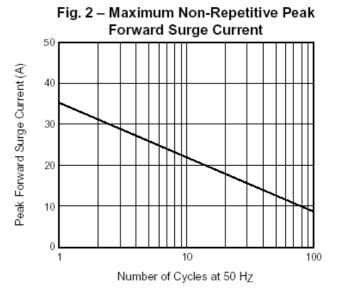


Fig. 4 – Typical Reverse Leakage Characteristics

